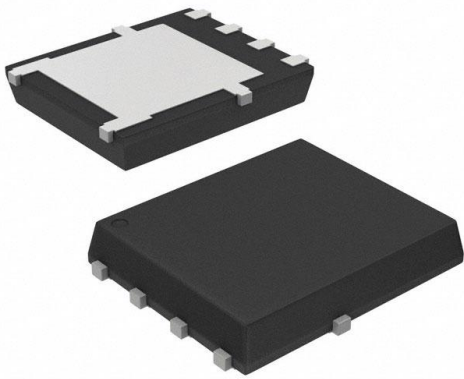


# NTMFS1D15N03CGT1G Datasheet

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<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	NTMFS1D15N03CGT1G-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	NTMFS1D15N03CGT1G
Description	MOSFET N-CH 30V 43A/245A 5DFN
Detailed Description	N-Channel 30 V 43A (Ta), 245A (Tc) 3.8W (Ta), 124W (Tc) Surface Mount 5-DFN (5x6) (8-SOFL)

This model NTMFS1D15N03CGT1G is available at DiGi Electronics.

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## Purchase and inquiry

Manufacturer Product Number:

NTMFS1D15N03CGT1G

Series:

-

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

30 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

2.2V @ 160µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-55°C ~ 175°C (Tj)

Supplier Device Package:

5-DFN (5x6) (8-SOFL)

Base Product Number:

NTMFS1

Manufacturer:

onsemi

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

43A (Ta), 245A (Tc)

Rds On (Max) @ Id, Vgs:

1.15mOhm @ 20A, 10V

Gate Charge (Qg) (Max) @ Vgs:

94 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

7300 pF @ 15 V

Power Dissipation (Max):

3.8W (Ta), 124W (Tc)

Mounting Type:

Surface Mount

Package / Case:

8-PowerTDFN, 5 Leads

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

# MOSFET - Power, Single N-Channel, SO8-FL

## 30 V, 1.15 mΩ, 245 A

### NTMFS1D15N03CG

#### Features

- Advanced Package (5x6 mm) with Excellent Thermal Conduction
- Ultra Low  $R_{DS(on)}$  to Improve System Efficiency
- These Devices are Pb-Free and are RoHS Compliant

#### Typical Applications

- Hot Swap Application
- Power Load Switch
- Battery Management and Protection

#### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DSS}$	30	V
Gate-to-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	$T_C = 25^\circ\text{C}$	$I_D$ 245 A
		$T_C = 100^\circ\text{C}$	173
Power Dissipation $R_{\theta JC}$ (Note 2)	Steady State	$T_C = 25^\circ\text{C}$	$P_D$ 124 W
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2)	Steady State	$T_A = 25^\circ\text{C}$	$I_D$ 43 A
		$T_A = 100^\circ\text{C}$	30
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	Steady State	$T_A = 25^\circ\text{C}$	$P_D$ 3.8 W
Pulsed Drain Current	$T_A = 25^\circ\text{C}, t_p = 10 \mu\text{s}$	$I_{DM}$ 900	A
Source Current (Body Diode)	$I_S$	112	A
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 23.2 \text{ A}$ )	$E_{AS}$	354	mJ
Operating Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	$T_L$	260	$^\circ\text{C}$

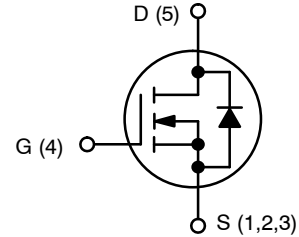
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

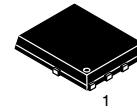
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	1.2	$^\circ\text{C}/\text{W}$
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

1. Surface-mounted on FR4 board using a 1 in<sup>2</sup>, 2 oz. Cu pad.
2. The entire application environment impacts the thermal resistance values shown. They are not constants and are only valid for the particular conditions noted. Actual continuous current will be limited by thermal & electro-mechanical application board design.  $R_{\theta CA}$  is determined by the user's board design.

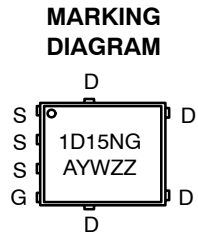
$V_{(BR)DSS}$	$R_{DS(ON) MAX}$	$I_D MAX$
30 V	1.15 mΩ @ 10 V	245 A



N-CHANNEL MOSFET



DFN5  
(SO-8FL)  
CASE 488AA  
STYLE 1



1D15NG = Specific Device Code  
 A = Assembly Location  
 Y = Year  
 W = Work Week  
 ZZ = Lot Traceability

#### ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

**NTMFS1D15N03CG****ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	$I_D = 250\ \mu\text{A}$ , ref to $25^\circ\text{C}$		14		mV/ $^\circ\text{C}$
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{GS} = 0\text{ V}, V_{DS} = 30\text{ V}$	$T_J = 25^\circ\text{C}$		1.0	$\mu\text{A}$
			$T_J = 125^\circ\text{C}$		100	
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = 20\text{ V}$			100	nA

**ON CHARACTERISTICS** (Note 3)

Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 160\ \mu\text{A}$	1.3		2.2	V
Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$	$I_D = 160\ \mu\text{A}$ , ref to $25^\circ\text{C}$		-4.7		mV/ $^\circ\text{C}$
Drain-to-Source On Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 20\text{ A}$		0.92	1.15	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 3\text{ V}, I_D = 20\text{ A}$		61		
Gate Resistance	$R_G$	$T_A = 25^\circ\text{C}$		1.7		$\Omega$

**CHARGES & CAPACITANCES**

Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V}, V_{DS} = 15\text{ V}, f = 1\text{ MHz}$		7300		pF
Output Capacitance	$C_{OSS}$			3600		
Reverse Transfer Capacitance	$C_{RSS}$			99		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = 10\text{ V}, V_{DS} = 15\text{ V}; I_D = 20\text{ A}$		94		nC
Threshold Gate Charge	$Q_{G(TH)}$			11		
Gate-to-Source Charge	$Q_{GS}$			19		
Gate-to-Drain Charge	$Q_{GD}$			6.9		

**SWITCHING CHARACTERISTICS** (Note 4)

Turn-On Delay Time	$t_{d(ON)}$	$V_{GS} = 10\text{ V}, V_{DS} = 15\text{ V}, I_D = 20\text{ A}, R_G = 3\ \Omega$		18		ns
Rise Time	$t_r$			13		
Turn-Off Delay Time	$t_{d(OFF)}$			72		
Fall Time	$t_f$			15		

**DRAIN-SOURCE DIODE CHARACTERISTICS**

Forward Diode Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = 10\text{ A}$	$T_J = 25^\circ\text{C}$		0.75	1.2	V
			$T_J = 125^\circ\text{C}$		0.60		
Reverse Recovery Time	$t_{RR}$	$V_{GS} = 0\text{ V}, V_{DS} = 15\text{ V}, I_S = 20\text{ A}, di_S/dt = 100\text{ A}/\mu\text{s}$		77		ns	
Reverse Recovery Charge	$Q_{RR}$			102		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. Switching characteristics are independent of operating junction temperatures.

**TYPICAL CHARACTERISTICS**

### NTMFS1D15N03CG

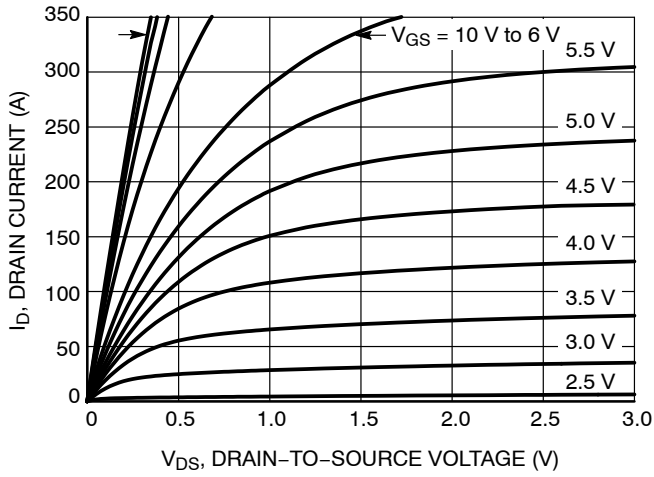


Figure 1. On-Region Characteristics

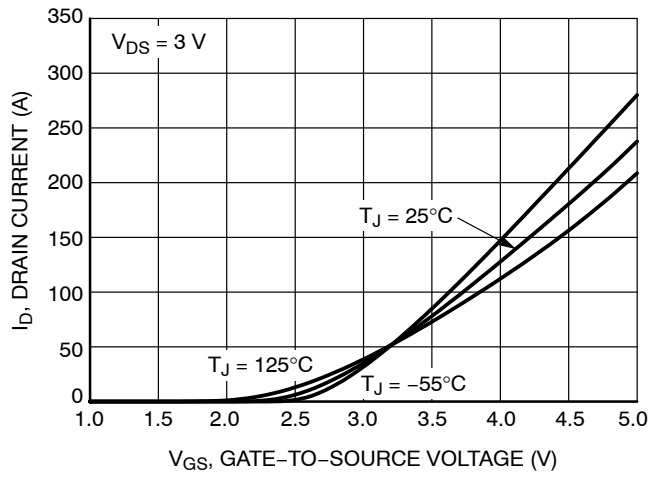


Figure 2. Transfer Characteristics

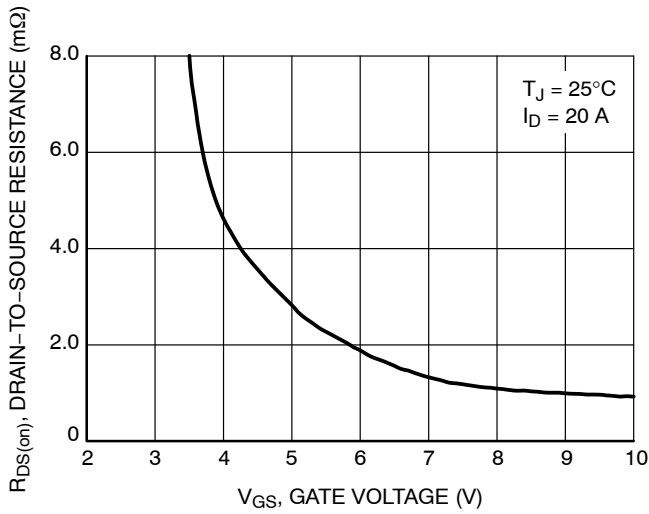


Figure 3. On-Resistance vs. Gate-to-Source Voltage

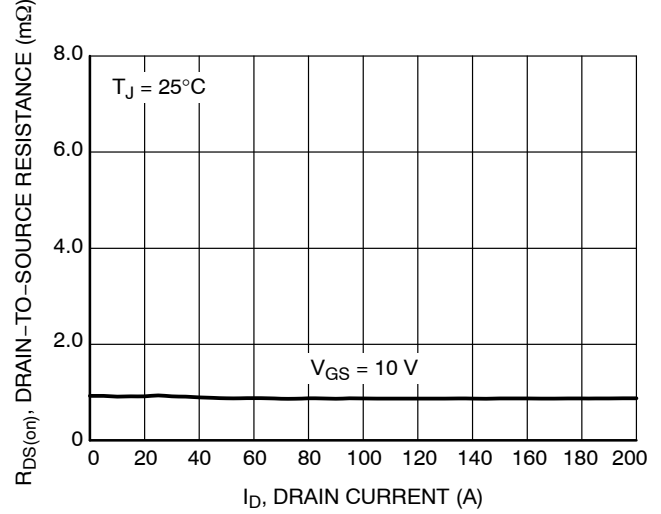


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

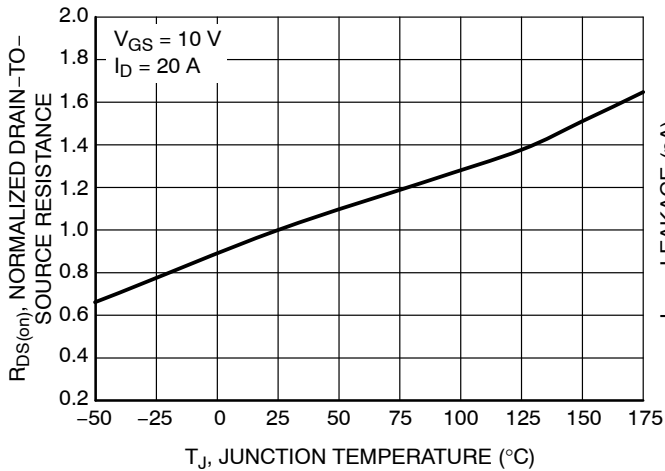


Figure 5. On-Resistance Variation with Temperature

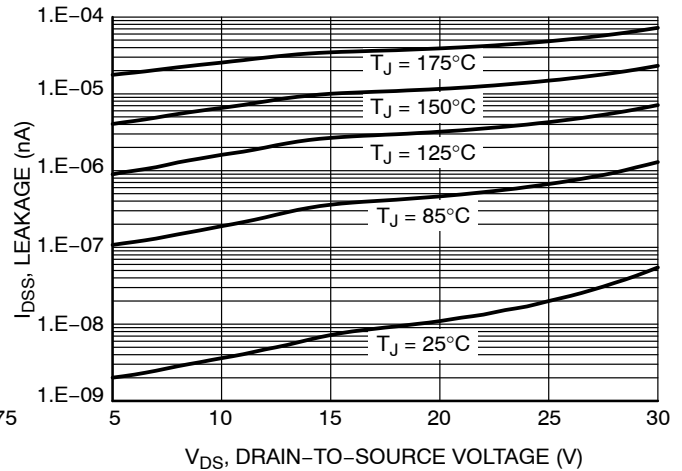


Figure 6. Drain-to-Source Leakage Current vs. Voltage

# NTMFS1D15N03CG

## TYPICAL CHARACTERISTICS

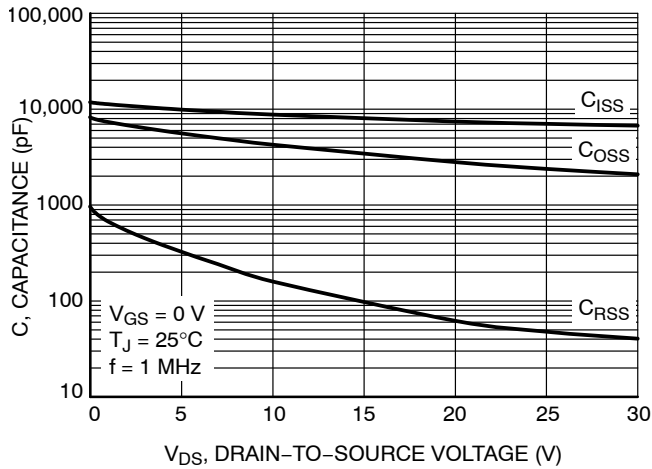


Figure 7. Capacitance Variation

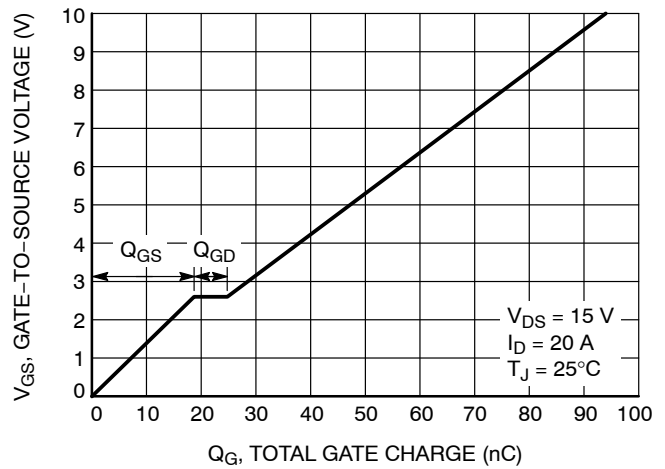


Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

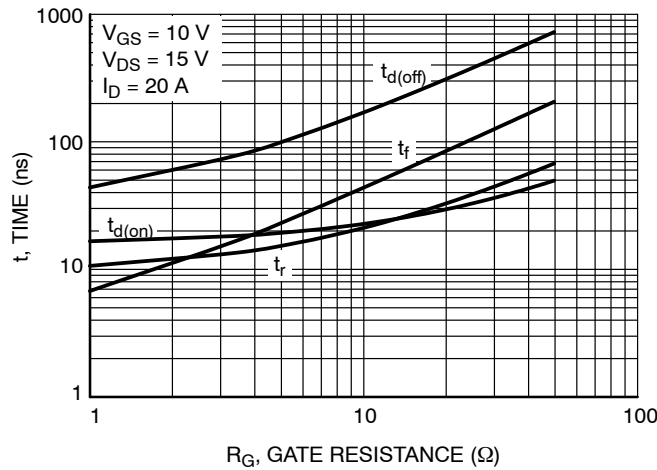


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

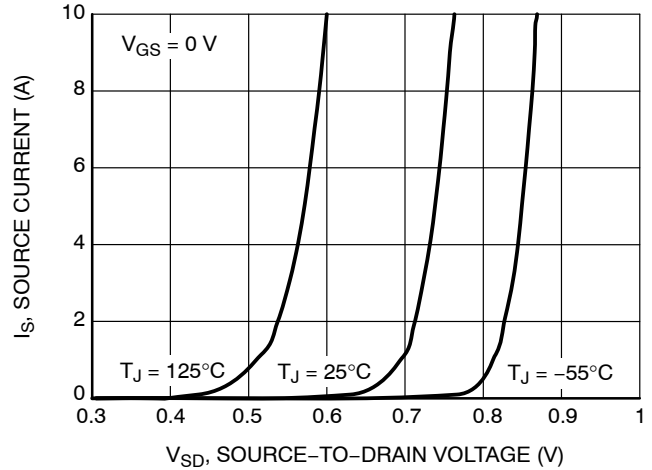


Figure 10. Diode Forward Voltage vs. Current

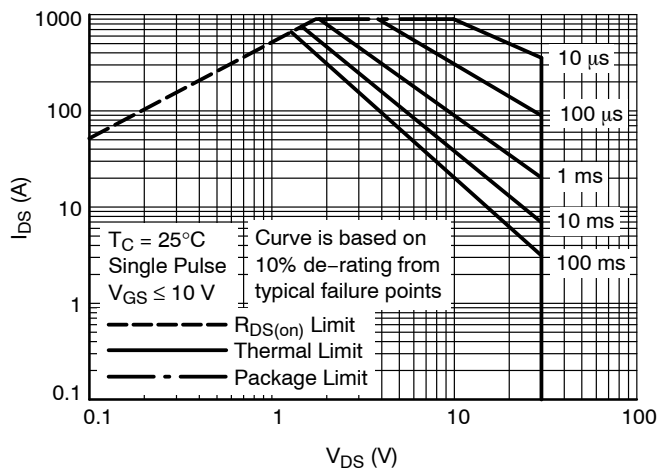


Figure 11. Safe Operating Area

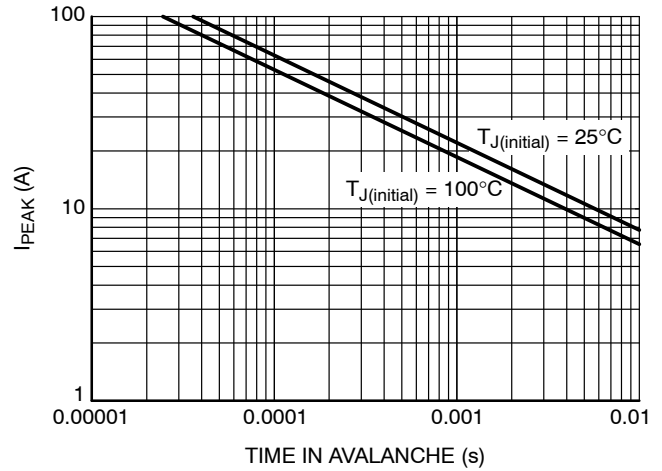


Figure 12.  $I_{PEAK}$  vs. Time in Avalanche

# NTMFS1D15N03CG

## TYPICAL CHARACTERISTICS

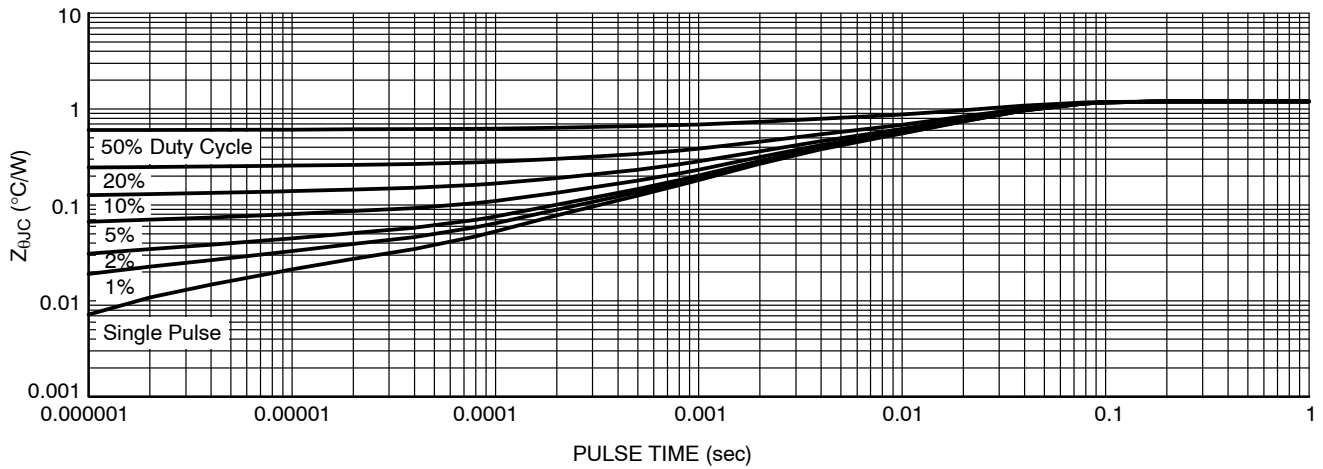


Figure 13. Thermal Impedance

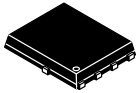
### DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping†
NTMFS1D15N03CGT1G	1D15NG	DFN5 (Pb-Free)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



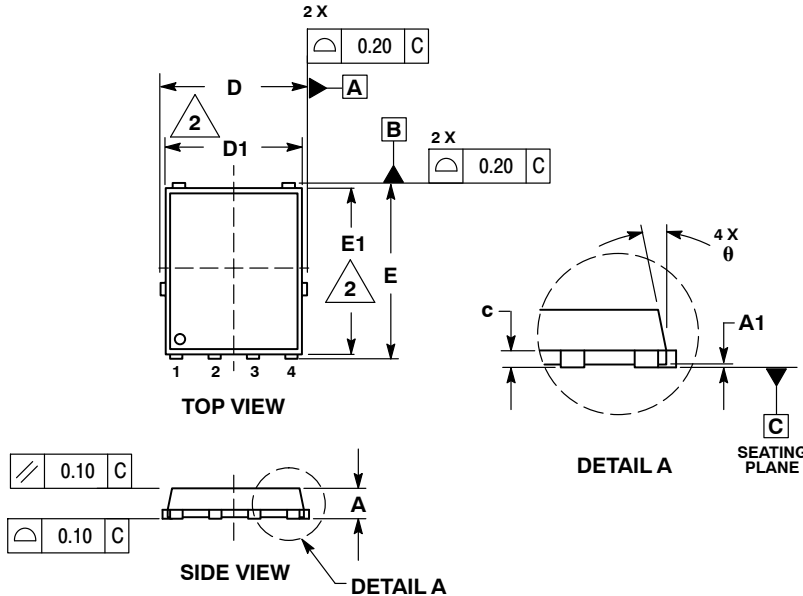
**MECHANICAL CASE OUTLINE  
PACKAGE DIMENSIONS**



1  
SCALE 2:1

**DFN5 5x6, 1.27P  
(SO-8FL)  
CASE 488AA  
ISSUE N**

DATE 25 JUN 2018



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

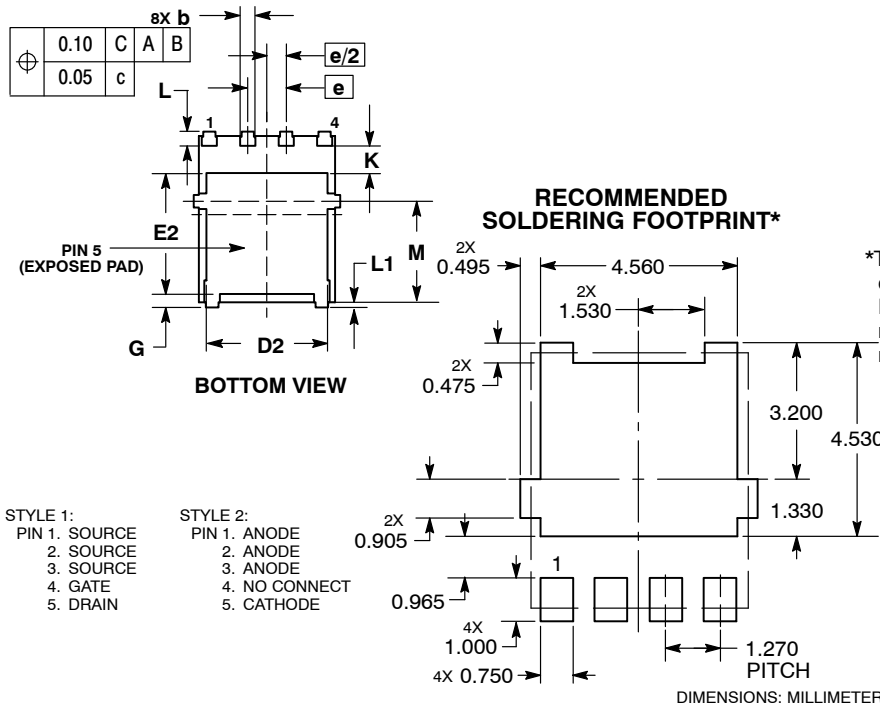
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.90	1.00	1.10
A1	0.00	---	0.05
b	0.33	0.41	0.51
c	0.23	0.28	0.33
D	5.00	5.15	5.30
D1	4.70	4.90	5.10
D2	3.80	4.00	4.20
E	6.00	6.15	6.30
E1	5.70	5.90	6.10
E2	3.45	3.65	3.85
e	1.27 BSC		
G	0.51	0.575	0.71
K	1.20	1.35	1.50
L	0.51	0.575	0.71
L1	0.125 REF		
M	3.00	3.40	3.80
θ	0°	---	12°

**GENERIC MARKING DIAGRAM\***



- XXXXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- W = Work Week
- ZZ = Lot Traceability

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



- STYLE 1:  
PIN 1. SOURCE  
2. SOURCE  
3. SOURCE  
4. GATE  
5. DRAIN
- STYLE 2:  
PIN 1. ANODE  
2. ANODE  
3. ANODE  
4. NO CONNECT  
5. CATHODE

DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<b>DOCUMENT NUMBER:</b>	<b>98AON14036D</b>	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
<b>DESCRIPTION:</b>	<b>DFN5 5x6, 1.27P (SO-8FL)</b>	<b>PAGE 1 OF 1</b>

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